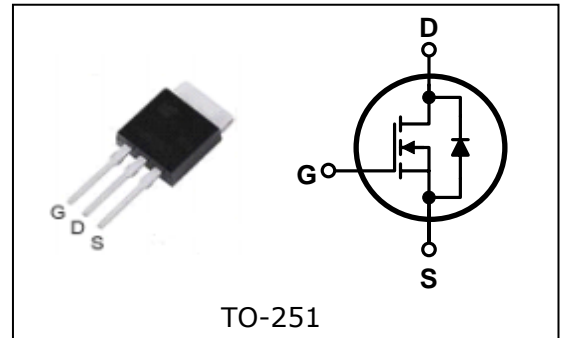


SWITCHING REGULATOR APPLICATIONS

Features

- High Voltage : $BV_{DSS}=400V(\text{Min.})$
- Low C_{RSS} : $C_{RSS}=23pF(\text{Typ.})$
- Low gate charge : $Qg=32nC(\text{Typ.})$
- Low $R_{DS(on)}$: $R_{DS(on)}=1.0\Omega(\text{Max.})$

PIN Connection



Ordering Information

| Type No. | Marking | Package Code |
|----------|---------|--------------|
| MU730 | MU730 | TO-251 |

Absolute maximum ratings ($T_C=25^\circ\text{C}$ unless otherwise noted)

| Characteristic | Symbol | Rating | Unit | |
|----------------------------------|-----------|-----------------------------|------------------|---|
| Drain-source voltage | V_{DSS} | 400 | V | |
| Gate-source voltage | V_{GSS} | ± 30 | V | |
| Drain current (DC) * | I_D | ($T_C=25^\circ\text{C}$) | 5.5 | A |
| | | ($T_C=100^\circ\text{C}$) | 2.9 | A |
| Drain current (Pulsed) * | I_{DM} | 22.0 | A | |
| Power dissipation | P_D | 48 | W | |
| Avalanche current (Single) ② | I_{AS} | 5.5 | A | |
| Single pulsed avalanche energy ② | E_{AS} | 330 | mJ | |
| Avalanche current (Repetitive) ① | I_{AR} | 5.5 | A | |
| Repetitive avalanche energy ① | E_{AR} | 7.4 | mJ | |
| Junction temperature | T_J | 150 | $^\circ\text{C}$ | |
| Storage temperature range | T_{stg} | -55~150 | | |

* Limited by maximum junction temperature

| Characteristic | | Symbol | Typ. | Max. | Unit |
|--------------------|------------------|---------------|------|------|---------------------------|
| Thermal resistance | Junction-case | $R_{th(J-C)}$ | - | 2.6 | $^\circ\text{C}/\text{W}$ |
| | Junction-ambient | $R_{th(J-A)}$ | - | 110 | |

Electrical Characteristics (T_C=25°C unless otherwise noted)

| Characteristic | Symbol | Test Condition | Min. | Typ. | Max. | Unit | |
|--------------------------------|---------------------|---|------|------|------|------|-----|
| Drain-source breakdown voltage | BV _{DSS} | I _D =250μA, V _{GS} =0 | 400 | - | - | V | |
| Gate threshold voltage | V _{GS(th)} | I _D =250μA, V _{DS} =V _{GS} | 2.0 | - | 4.0 | V | |
| Drain-source cut-off current | I _{DSS} | V _{DS} =400V, V _{GS} =0 | - | - | 10 | μA | |
| Gate leakage current | I _{GSS} | V _{DS} =0V, V _{GS} =±30V | - | - | ±100 | nA | |
| Drain-source on-resistance ④ | R _{DS(ON)} | V _{GS} =10V, I _D =2.75A | - | 0.83 | 1.0 | Ω | |
| Forward transfer conductance ④ | g _{fs} | V _{DS} =50V, I _D =2.75A | - | 4.5 | - | S | |
| Input capacitance | C _{iss} | V _{GS} =0V, V _{DS} =25V, f=1MHz | - | 550 | 720 | pF | |
| Output capacitance | C _{oss} | | - | 85 | 110 | | |
| Reverse transfer capacitance | C _{rss} | | - | 23 | 30 | | |
| Turn-on delay time | t _{d(on)} | V _{DD} =200V, I _D =5.5A R _G =25Ω | - | 55 | 120 | ns | |
| Rise time | t _r | | - | 15 | 40 | | |
| Turn-off delay time | t _{d(off)} | | ③④ | - | 50 | | 110 |
| Fall time | t _f | | - | 85 | 180 | | |
| Total gate charge | Q _g | V _{DS} =320V, V _{GS} =10V I _D =5.5A | - | 32 | 38 | nC | |
| Gate-source charge | Q _{gs} | | - | 4.3 | - | | |
| Gate-drain charge | Q _{gd} | | ③④ | - | 14 | | - |

Source-Drain Diode Ratings and Characteristics (T_C=25°C unless otherwise noted)

| Characteristic | Symbol | Test Condition | Min. | Typ. | Max. | Unit |
|---------------------------|-----------------|--|------|------|------|------|
| Source current (DC) | I _S | Integral reverse diode in the MOSFET | | | 5.5 | A |
| Source current (Pulsed) ① | I _{SM} | | | | 22 | |
| Forward voltage ④ | V _{SD} | V _{GS} =0V, I _S A=5.5A | | | 1.5 | V |
| Reverse recovery time | t _{rr} | I _S =5.5A, V _{GS} =0V dI _F /dt=100A/us | - | 265 | - | ns |
| Reverse recovery charge | Q _{rr} | | - | 2.32 | - | μC |

Note ;

- ① Repetitive rating : Pulse width limited by maximum junction temperature
- ② L=18.5mH, I_{AS}=5.5A, V_{DD}=50V, R_G=25Ω, Starting T_J=25°C
- ③ Pulse Test : Pulse width≤300us, Duty cycle≤2%
- ④ Essentially independent of operating temperature

Electrical Characteristic Curves

Fig. 1 $I_D - V_{DS}$

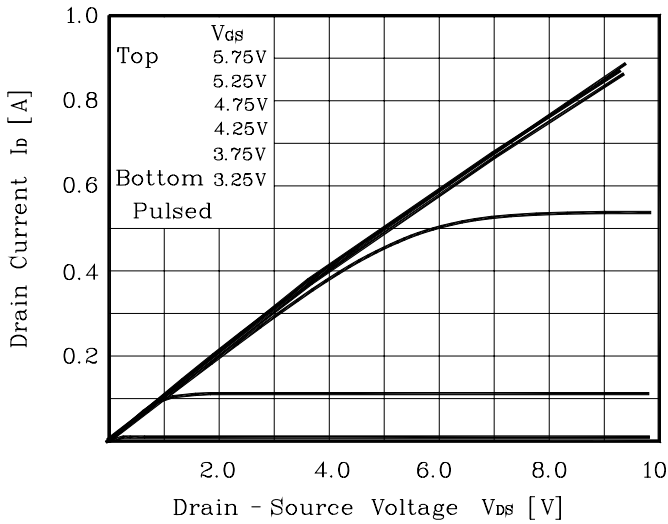


Fig. 2 $I_D - V_{GS}$

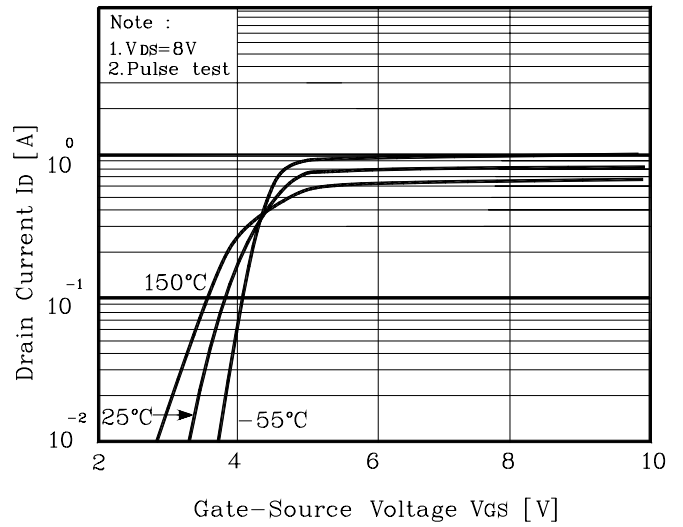


Fig. 3 $R_{DS(on)} - I_D$

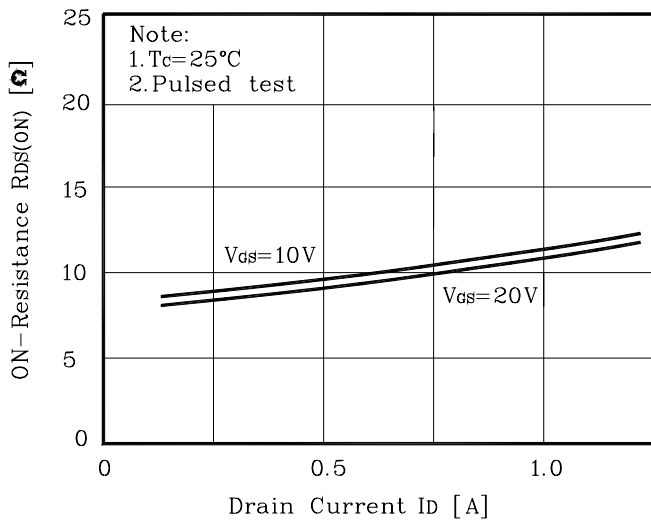


Fig. 4 $I_S - V_{SD}$

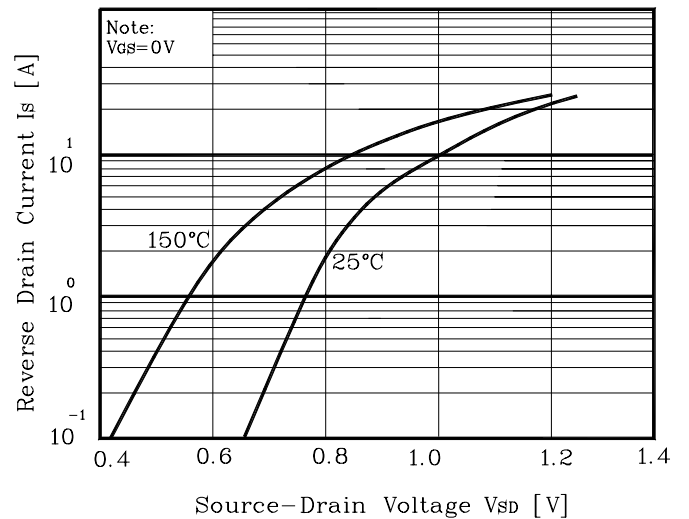


Fig. 5 Capacitance - V_{DS}

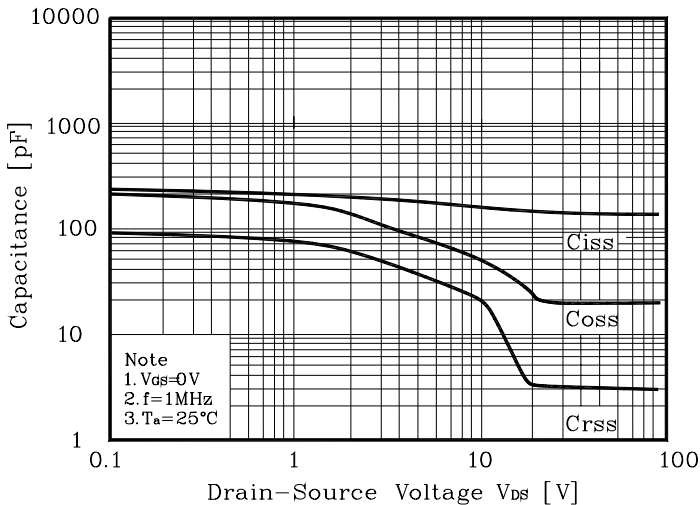


Fig. 6 $V_{GS} - Q_G$

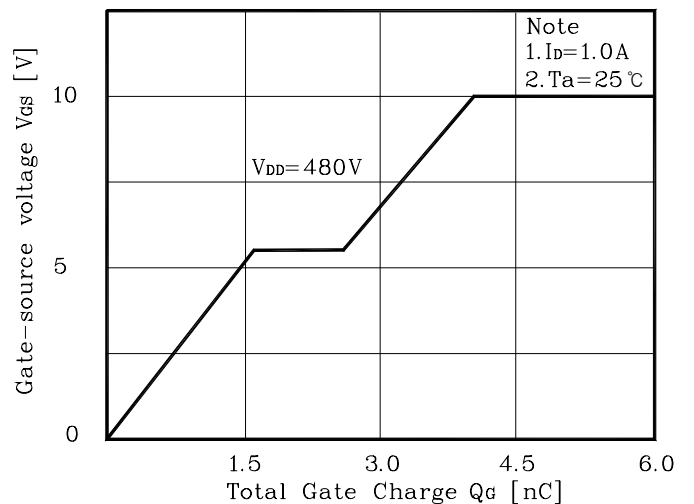


Fig. 7 $V_{DSS} - T_J$

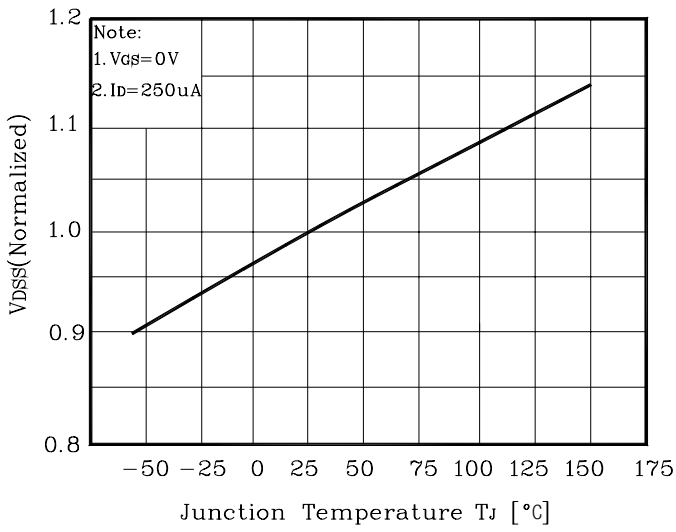


Fig. 8 $R_{DS(on)} - T_J$

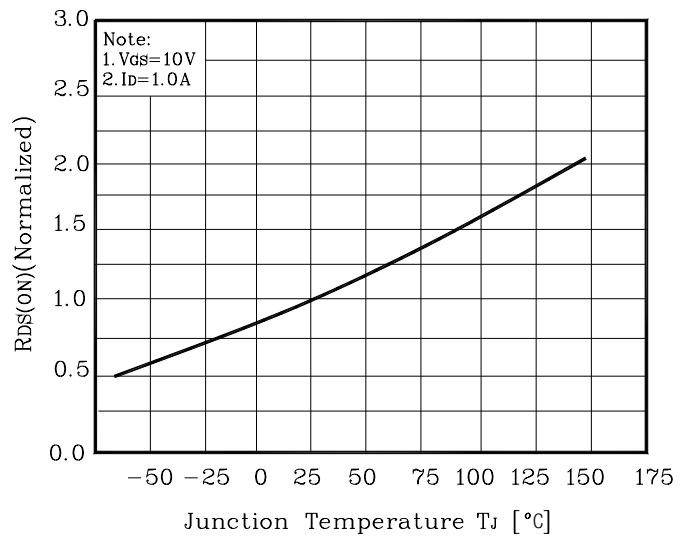


Fig. 9 $I_D - T_c$

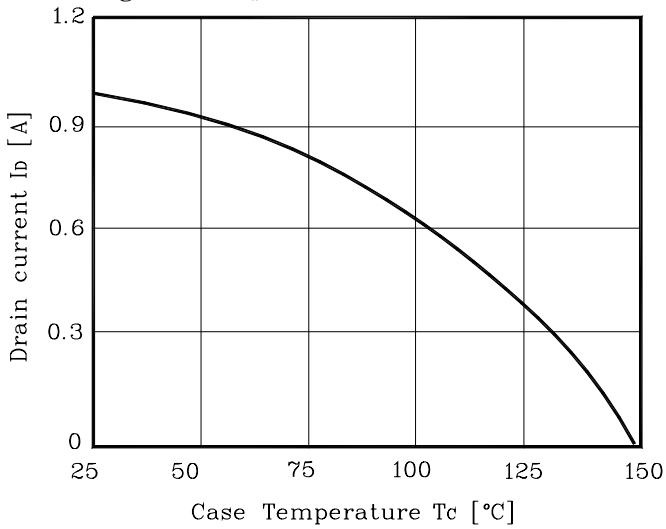


Fig. 10 Safe Operating Area

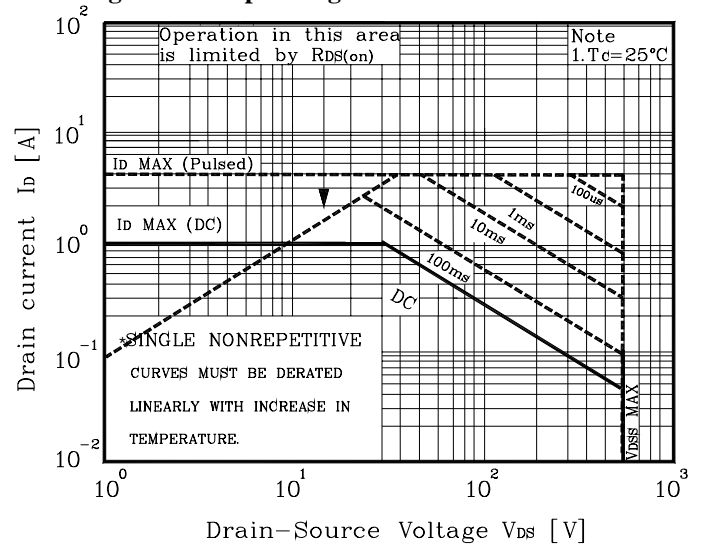


Fig. 11 Gate Charge Test Circuit & Waveform

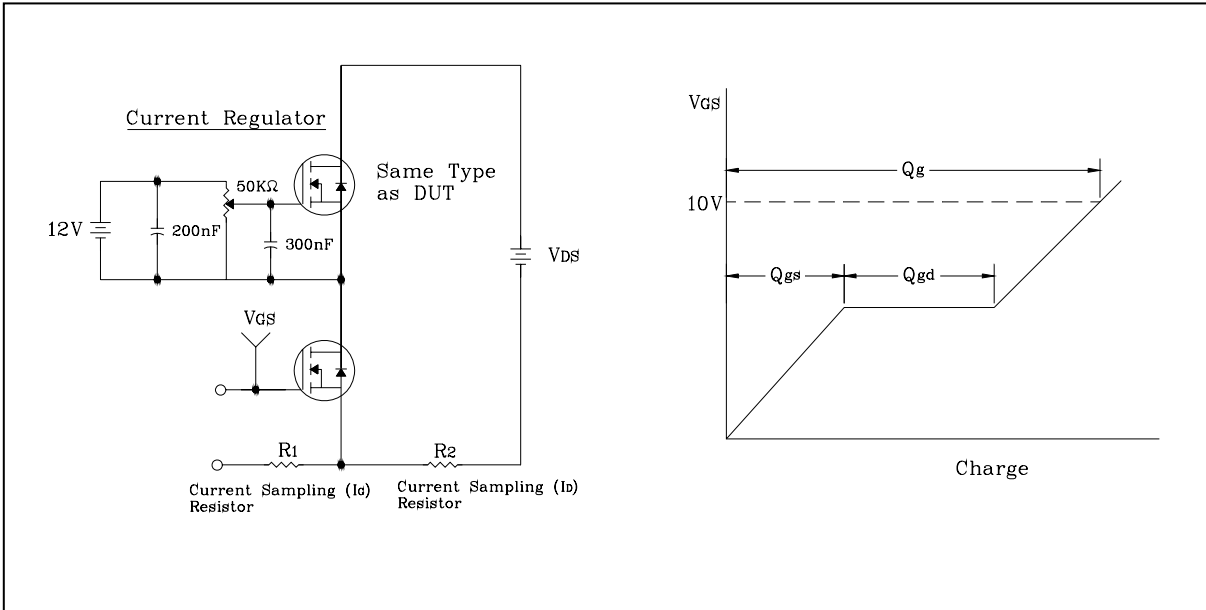


Fig. 12 Resistive Switching Test Circuit & Waveform

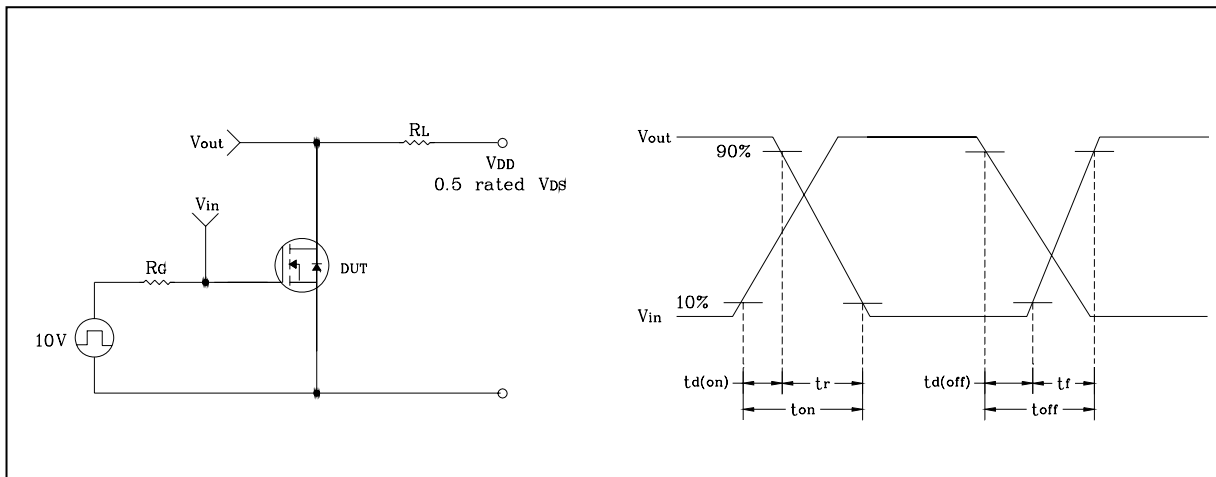


Fig. 13 EAS Test Circuit & Waveform

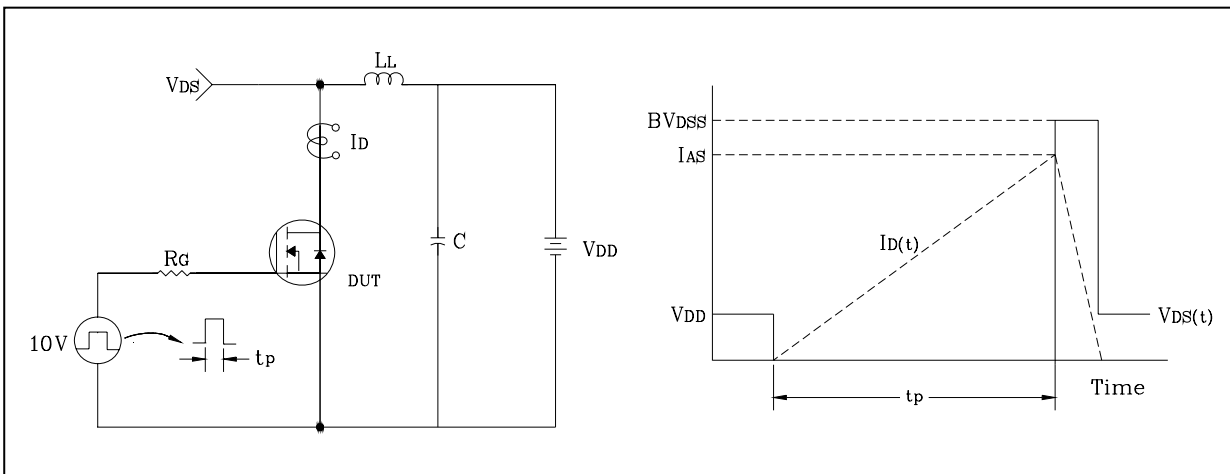
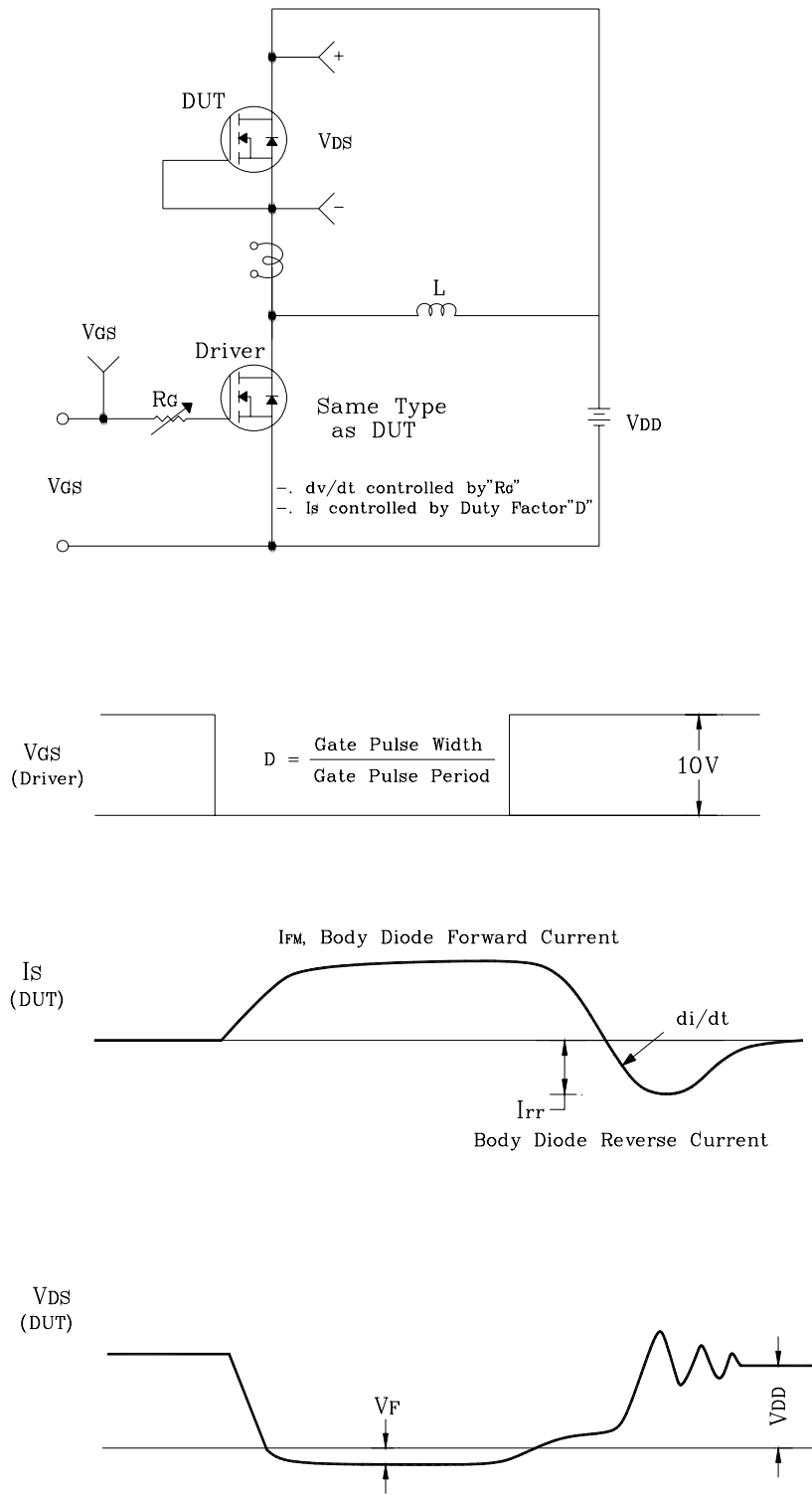
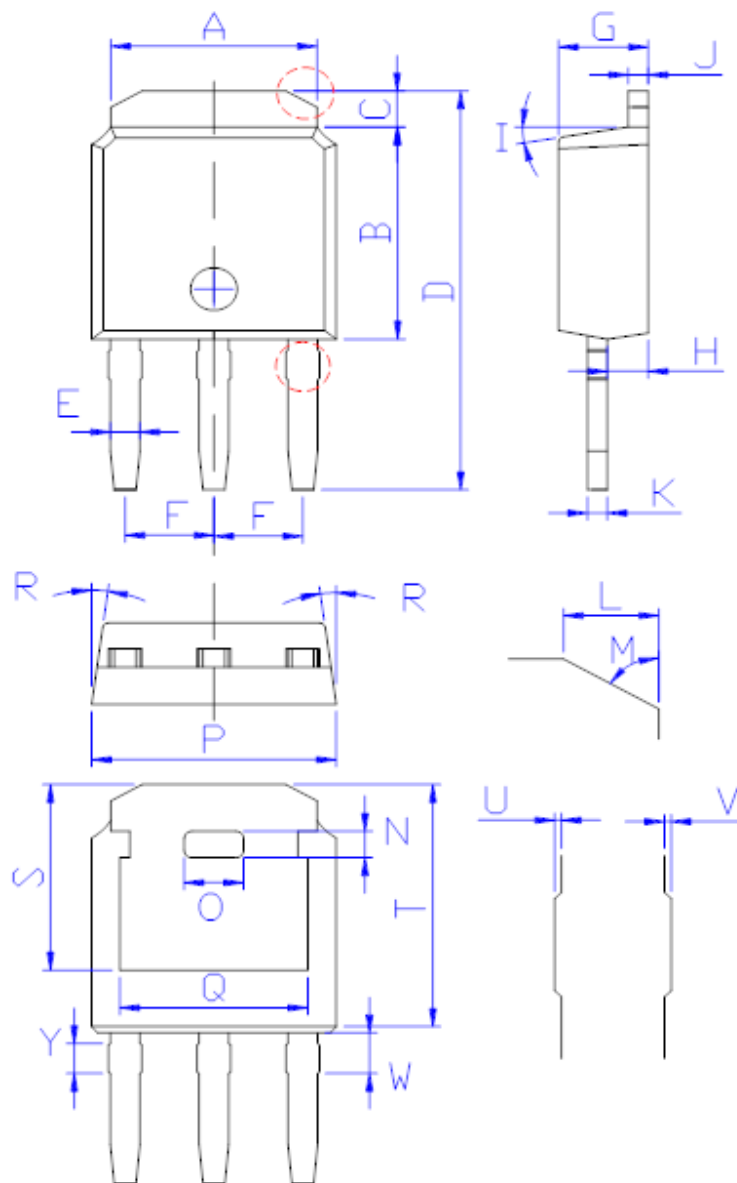


Fig. 14 Diode Reverse Recovery Time Test Circuit & Waveform



Outline Dimension

unit: mm



| DIM | MILLIMETERS |
|-----|--------------|
| A | 5.34 ± 0.30 |
| B | 6.00 ± 0.30 |
| C | 1.05 ± 0.30 |
| D | 11.31 ± 0.30 |
| E | 0.76 ± 0.15 |
| F | 2.28 ± 0.15 |
| G | 2.30 ± 0.30 |
| H | 1.06 ± 0.30 |
| I | (4-10)° |
| J | 0.51 ± 0.15 |
| K | 0.52 ± 0.15 |
| L | 0.80 ± 0.30 |
| M | 60° |
| N | 0.75 ± 0.30 |
| O | 1.80 ± 0.30 |
| P | 6.60 ± 0.30 |
| Q | 4.85 ± 0.30 |
| R | (4-8.5)° |
| S | 5.30 ± 0.30 |
| T | 6.90 ± 0.30 |
| U | 0.05 ± 0.05 |
| V | 0.05 ± 0.05 |
| W | 1.15 ± 0.25 |
| Y | 0.85 ± 0.25 |

(单位: mm)